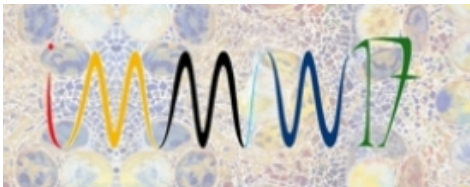


The New Digital Integrator

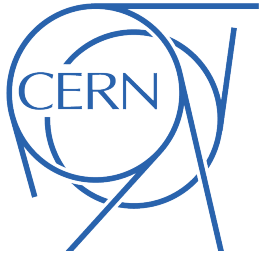
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¹ University of Sannio, Italy

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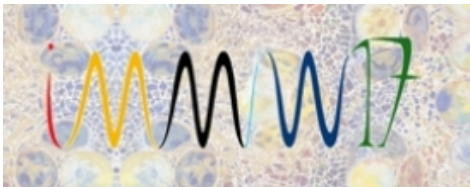


Outline



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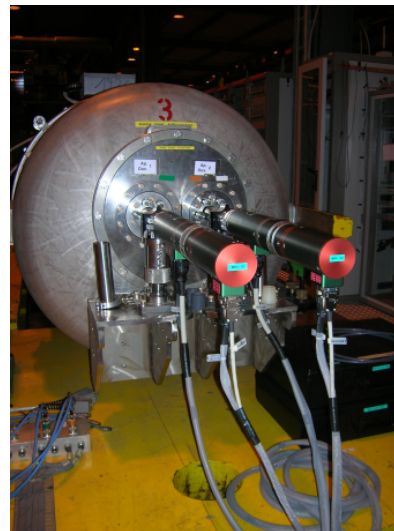
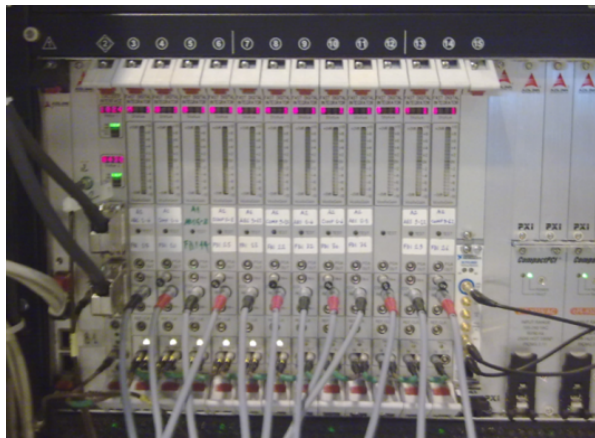
- ***Introduction***
- ***On-field feedbacks***
- ***FDI architecture***
- ***New Digital Integrator***
 - ***Requirements***
 - ***Concept design***
 - ***Specific solutions***
- ***Conclusions***



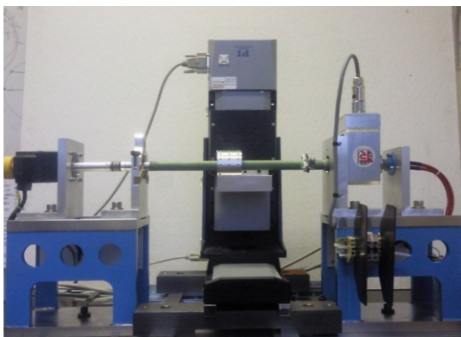
IMMW17 La Mola, Terrassa-Barcelona, September 18-23, 2011

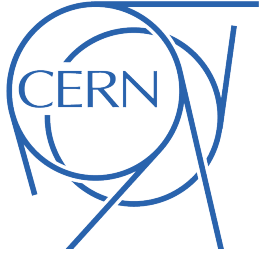
Fast Digital Integrator on the field:

- ***LHC dipole test bench (12 FDI's)***
 - ***Decay-snapback studies***
- ***Magnet prototype bench (6 FDI's)***
 - ***Nb₃Sn magnet prototypes***



- **Linac4 bench (3 FDI)**
 - **Permanent small quadrupole**
 - **Fast-pulsed quadrupole**
- **Magnetic properties bench (1 FDI)**
- **Superconducting cable test (1 FDI)**
 - **Current experiments in cryo-conditions**





On-field feedbacks 1 / 2

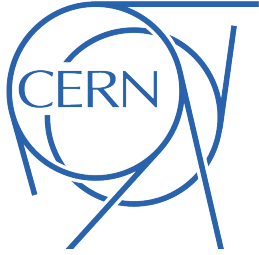


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- **Low throughput**
 - **low measurement bandwidth for several FDIs**

- **Lack of on-board memory**
 - **non-optimized data exchange**
 - **no on-line complex algorithms**





On-field feedbacks 2/2



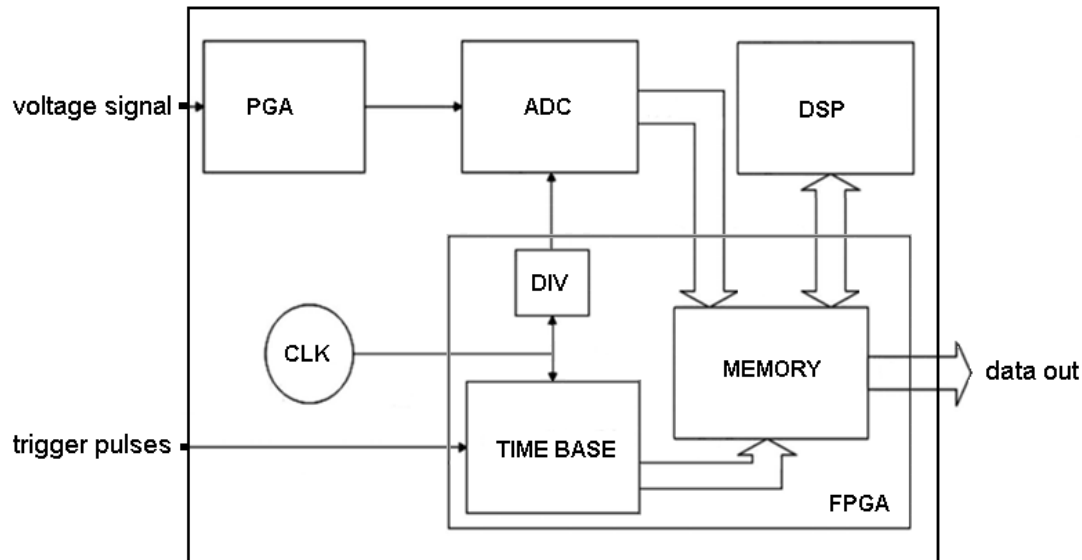
6

- **Self-calibration ineffectiveness**
 - **residual gain and offset errors**
- **EMC problems of the board**
 - **Noise at high gains**
- **Scarce maintainability of the firmware**
 - **Incremental development of FPGA code**
 - **Difficult upgrade of DSP fw**



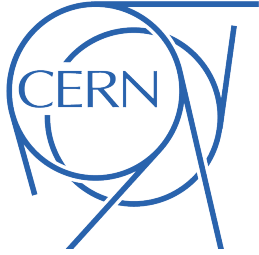
FDI architecture

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Fast Digital Integrator is based on:

- ☐ ***High-performance analogue front-end with programmable gain (0.1 to 100)***
- ☐ ***Fast- and high-resolution ADC (670 kS/s, 18 bit)***
- ☐ ***High-resolution time base (50 ns)***
- ☐ ***DSP for integration (trapezoidal rule with interpolation) and other algorithms***
- ☐ ***FPGA as I/O processor and RAM memory***
- ☐ ***cPCI interface (6U PXI rack)***



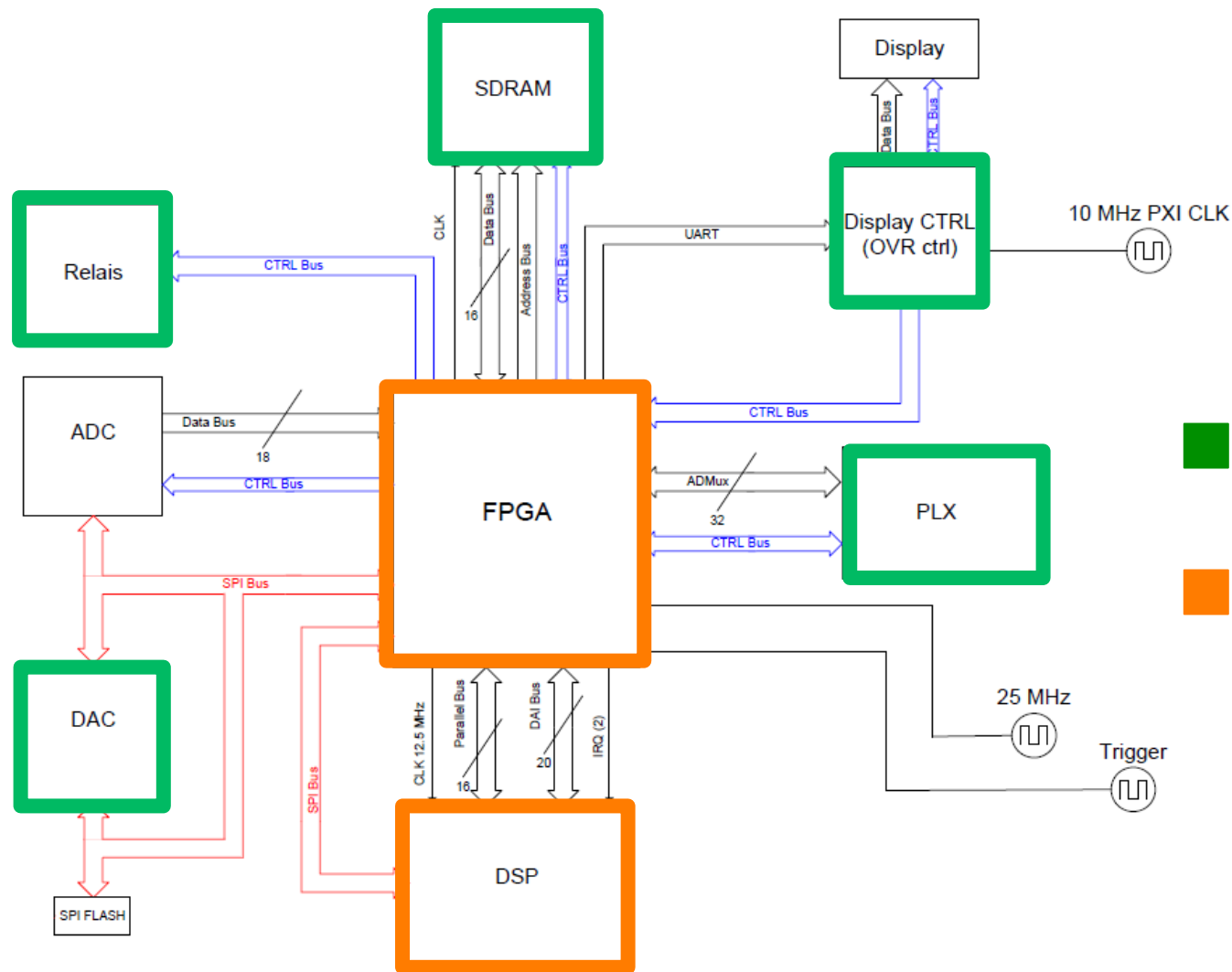
New instrument requirements



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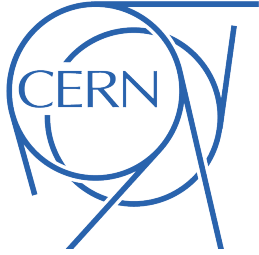
- ☐ *higher throughput*
- ☐ *more memory*
- ☐ *self-calibration upgrade*
- ☐ *optimization of the analogue front-end*
- ☐ *new display and reset management*
- ☐ *re-design of modular code for DSP and FPGA*
- ☐ *remote DSP firmware update from cPCI*
- ☐ *fast gain change*





■ *New blocks*

■ *Re-designed blocks*



Specific solutions: throughput 1 / 2

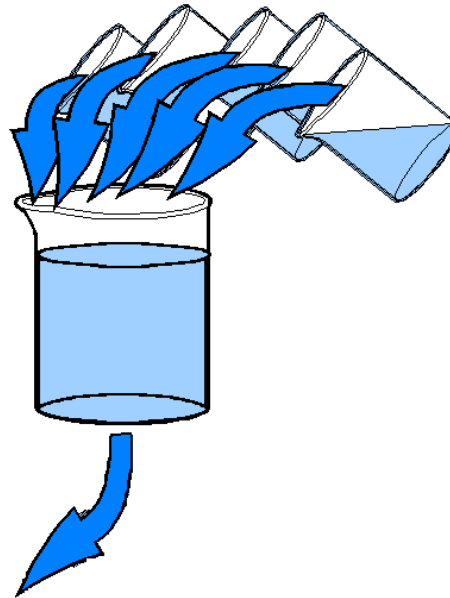


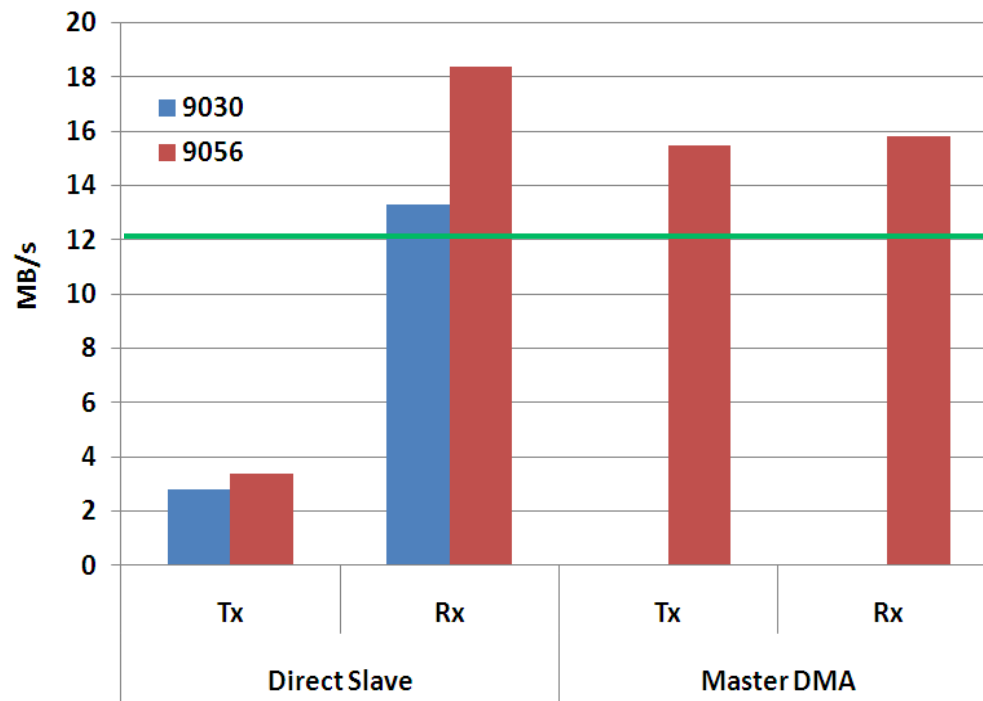
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Use case for LHC dipole testing

12 FDI @ 250 kS/s

$250 \text{ kS/s} \times 4 \text{ B/S} \times 12 = 12 \text{ MB/s}$





❑ *Plx PCI9030 (FDI)*

❑ *Plx PCI9056*

**Average rates measured in actual tests of 1 min, carried out by specific utility included into the PLX driver*

Solution: PCI9056 implementing Master DMA mode

Optimization of the data exchange requires more memory.

Use case:

1 FDI @ 250 kS/s

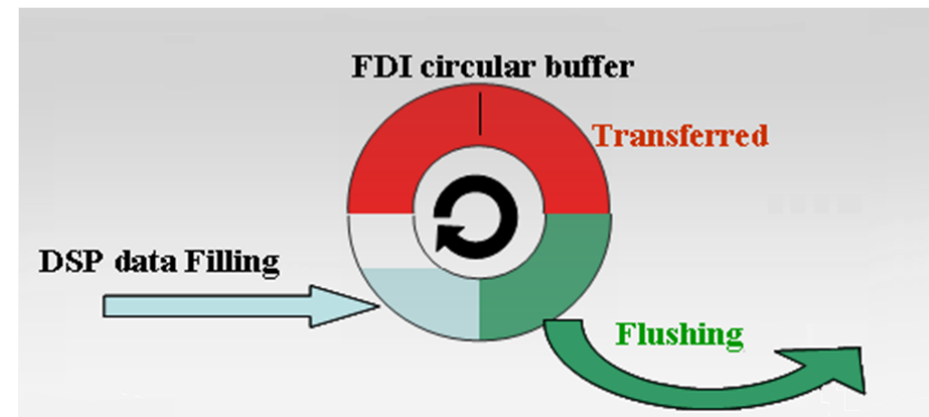
1 MB/s

2 MB to store 1 s of acquisition.

Several MB are required.

FDI has only:

- ❑ **RAM of the DSP (few kB)**
- ❑ **RAM in FPGA (few kB)**



Solution: DRAM module of 16 Mb x 16 x 4 driven by the FPGA.

More complex algorithms (several seconds) can be executed on-board.

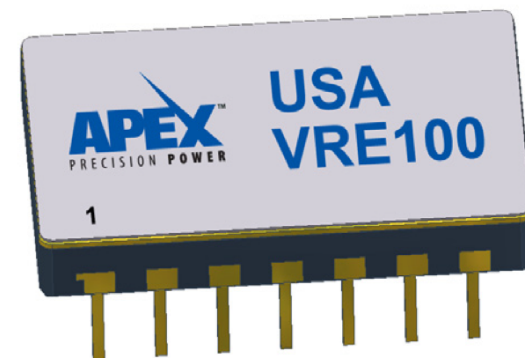
FDI has a high quality ± 10 V ref source:

1.09 ppm/°C, 6 ppm/1000 h

The references for the various gains (13 gains from 0.1 to 100) are obtained by

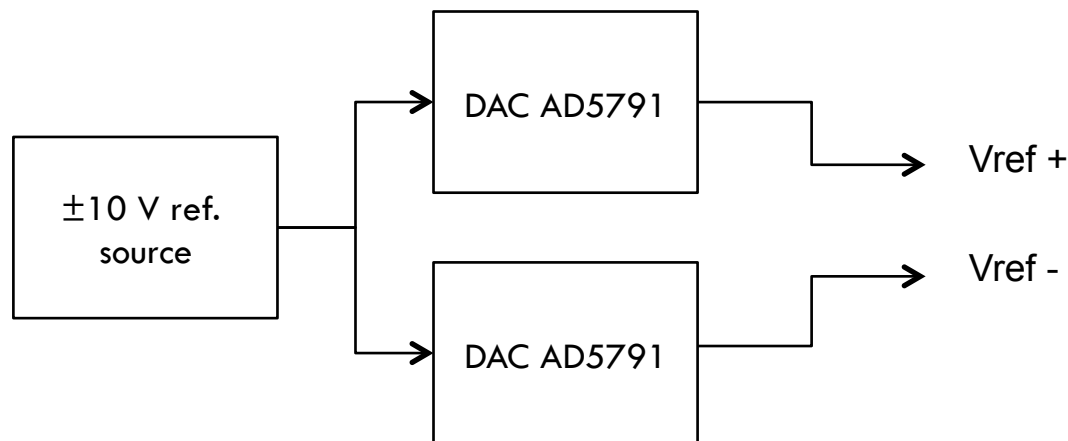
- ☐ ***dividers***
- ☐ ***amplifiers***
- ☐ ***analog mux's***

with a significant performance loss (0.1 %)



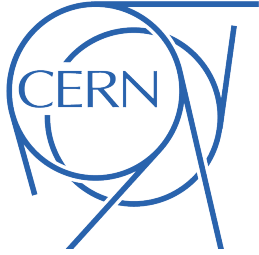
Solution: instead of dividers/amplifiers, 2 DAC AD5791

- ❑ ***20 bits, 1 ppm INL***
- ❑ ***0.19 LSB long-term linearity***
- ❑ ***0.05 ppm/°C***



The availability of a large set of V_{ref} allows to more effective calibration algorithms.

The expected offset and gain errors are in the order of tens of ppm.



Conclusions

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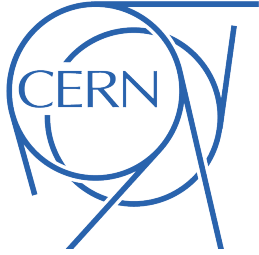
FDI has been exploited at CERN intensively.

The physiological development and the feedbacks from field have led to the design of a new instrument.

The new integrator will provide:

- ☐ *enhanced throughput to optimize the use of the instrument also in multi-card benches;*
- ☐ *on-board memory to manage the data exchange and to allow more complex algorithms;*
- ☐ *lower gain errors with more stable voltage reference.*

The first two prototypes are in production now and will be characterized metrologically for the end of 2011.



Thank you



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Questions?

